

PRELIMINARY DATA SHEET

SKY65170-21: 860 – 960 MHz, 0.5 W High Power Power Amplifier

Applications

- CDMA2000 cellular band
- WCDMA, Bands V and VIII
- Femtocell transmitters

Features

- Wideband frequency operation: 860 to 960 MHz
- High gain: > 30 dB
- OP1dB: > +27 dBm
- ACPR ≤ -51 dBc for P_{OUT} ≥ +18 dBm
- ACLR ≤ -45 dBc for P_{OUT} ≥ +18 dBm
- Single DC supply: 5 V
- Internal RF match and bias circuits
- PA on/off control voltage
- Small footprint, MCM (20-pin, 6 x 6 mm) SMT package (MSL3, 260 °C per JEDEC J-STD-020)

NEW

Skyworks offers lead (Pb)-free RoHS (Restriction of Hazardous Substances) compliant packaging.



Description

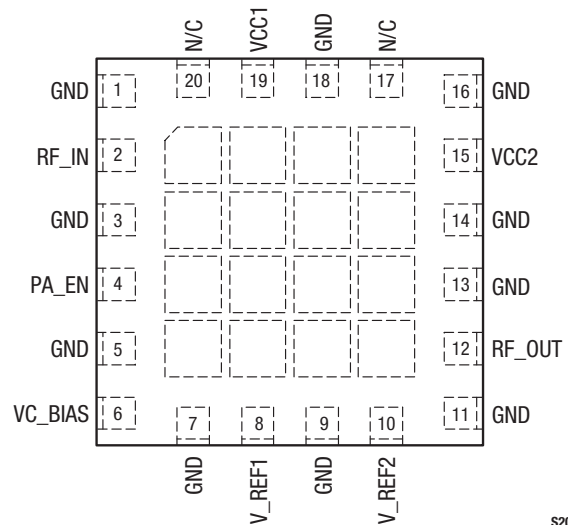
Skyworks SKY65170-21 is a fully-matched, 0.5 W Power Amplifier (PA) with high efficiency, designed for use in the 860 to 960 MHz band.

The device is fabricated using Skyworks high reliability Indium Gallium Phosphide (InGaP) Heterojunction Bipolar Transistor (HBT) technology. This process allows for single supply operation while maintaining high efficiency and good linearity.

The SKY65170-21 contains all of the active bias and RF matching circuits, which make it easy to integrate into 50 Ω RF systems. The internal input and output match are optimized for gain, 1 dB Output Compression Point (OP1dB), Adjacent Channel Leakage Ratio (ACLR), Adjacent Channel Power Ratio (ACPR), and efficiency when integrated in a 50 Ω system.

The primary bias to the SKY65170-21 can be supplied directly from a single 5 VDC supply. The PA is designed to operate with lower current by reducing the bias voltage.

The device is internally matched and mounted in a 20-pin, 6 x 6 mm Multi-Chip Module (MCM) Surface-Mounted Technology (SMT) package, which allows for a highly manufacturable low cost solution. The device package and pinout for the 20-pin MCM are shown in Figure 1. A block diagram of the SKY65170-21 is shown in Figure 2.



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Figure 1. SKY65170-21 Pinout – 20-Pin MCM (Top View)

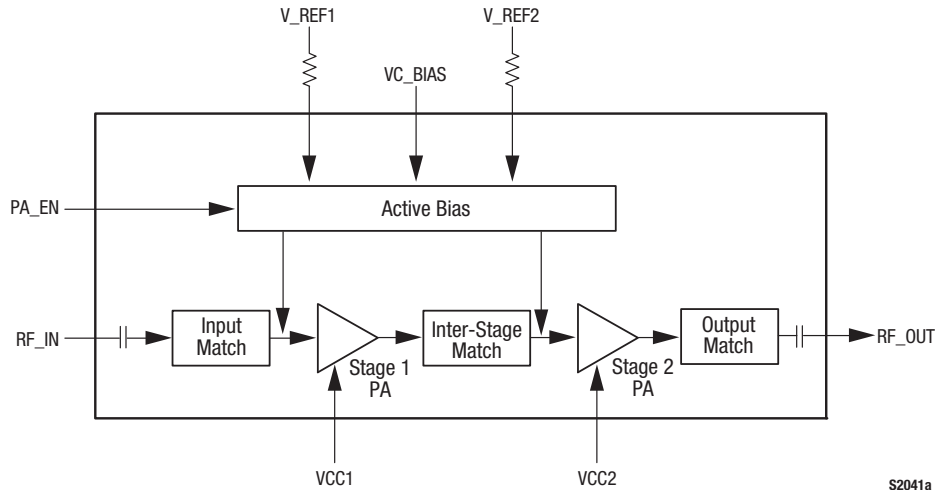


Figure 2. SKY65170-21 Block Diagram

Technical Description

The SKY65170-21 PA contains all of the needed RF matching and DC biasing circuits. The device is a two-stage, HBT InGaP device optimized for high linearity and power efficiency. These features make the device suitable for wideband digital applications, where PA linearity and power consumption are of critical importance (e.g., femtocell and infrastructure applications).

The device has been characterized with a standard CDMA2000 modulated signal. Under these stringent test conditions, the device exhibits excellent spectral purity and power efficiency.

Electrical and Mechanical Specifications

Signal pin assignments and functional pin descriptions are described in Table 1. The absolute maximum ratings of the SKY65170-21 are provided in Table 2. Electrical specifications are provided in Table 3.

Typical performance characteristics of the SKY65170-21 are illustrated in Figures 3 through 7.

Table 1. SKY65170-21 Signal Descriptions

Pin #	Name	Description	Pin #	Name	Description
1	GND	Ground	11	GND	Ground
2	RF_IN	RF input	12	RF_OUT	RF output
3	GND	Ground	13	GND	Ground
4	PA_EN	PA enable	14	GND	Ground
5	GND	Ground	15	VCC2	Stage 2 collector voltage, 5 V
6	VC_BIAS	Bias voltage, 5 V	16	GND	Ground
7	GND	Ground	17	N/C	No connection
8	V_REF1	Bias reference 1 voltage, 5 V	18	GND	Ground
9	GND	Ground	19	VCC1	Stage 1 collector voltage, 5 V
10	V_REF2	Bias reference 2 voltage, 5 V	20	N/C	No connection

Table 2. SKY65170-21 Absolute Maximum Ratings (Note 1)

Parameter	Symbol	Minimum	Maximum	Units
RF output power	P _{OUT}		+30	dBm
Supply voltage	VCC1, VCC2, V_REF1, V_REF2, VC_BIAS		5.5	V
PA enable voltage	PA_EN	3	5	V
Total supply current	I _{CC}		700	mA
Storage temperature	T _{ST}	-65	+125	°C
Junction temperature	T _J		+150	°C
Thermal resistance	Θ _{JC}		30	°C/W

Note 1: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

CAUTION: Although this device is designed to be as robust as possible, Electrostatic Discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

Table 3. SKY65170-21 Recommended Operating Conditions

Parameter	Symbol	Minimum	Typical	Maximum	Units
Frequency range	f	860		960	MHz
Supply voltage (Note 1)	VCC1, VCC2	4.75	5.00	5.25	V
Bias voltage (Note 1)	VC_BIAS	4.75	5.00	5.25	V
Reference voltage (Note 1)	V_REF1, V_REF2		2.60	2.75	V
Reference current	I_REF1, I_REF2		12		mA
PA enable current	I _{PA_EN}		<1		mA
PA enable voltage (Note 1)	PA_EN	3		5	V
Case operating temperature	T _C	-40	+25	+85	°C

Note 1: Voltage levels measured at the pins of the package. The Evaluation Board supply voltage levels may be different. Refer to the Evaluation Board schematic diagram in this Data Sheet.

Table 4. SKY65170-21 Electrical Specifications (Note 1)**(VCC1 = VCC2 = V_REF1 = V_REF2 = VC_BIAS = 5 V, T_c = +25 °C, f = 880 MHz, PA_EN = 5 V, CW, Unless Otherwise Noted)**

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Output power @ 1 dB compression	OP1dB		+27	+28		dBm
Small signal gain	S ₂₁	P _{IN} = -15 dBm	30	32		dB
Adjacent Channel Power Ratio	ACPR1	@750 kHz, P _{OUT} = +18 dBm		-55	-48	dBc
	ACPR2	@1.98 MHz, P _{OUT} = +18 dBm		-74	-63	dBc
Adjacent Channel Leakage Ratio	ACLR	P _{OUT} = +18 dBm, with WCDMA test model 1, 64 DPCH		-45		dBc
3 rd Order Output Intercept Point	OIP3	P _{TONE} = +15 dBm, frequency spacing = 1 MHz		+45		dBm
Quiescent Current	I _Q	No RF input		200		mA
Operating current	I _{CC}	P _{OUT} = +18 dBm		220		mA
Noise Figure	NF			6.5		dB
Input return loss	S ₁₁	P _{IN} = -15 dBm	10	14		dB
Output return loss	S ₂₂	P _{IN} = -15 dBm	9	12		dB
Voltage Standing Wave Ratio for stable operation	VSWR				8:1	-
Leakage current	I _{LEAKAGE}	PA_EN = 0 V		1.2		μA

Note 1: Performance is guaranteed only under the conditions listed in this Table.

Typical Performance Characteristics

(VCC1 = VCC2 = V_REF1 = V_REF2 = VC_BIAS = 5 V, Tc = +25 °C, f = 880 MHz, PA_EN = 5 V, CW, Unless Otherwise Noted)

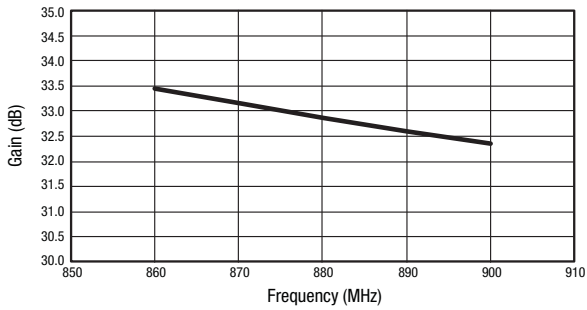


Figure 3. Gain vs Frequency

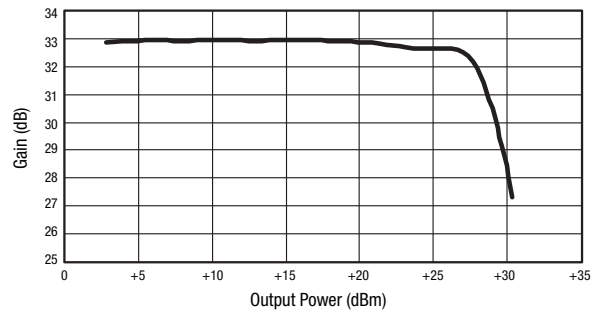


Figure 4. Gain vs Output Power

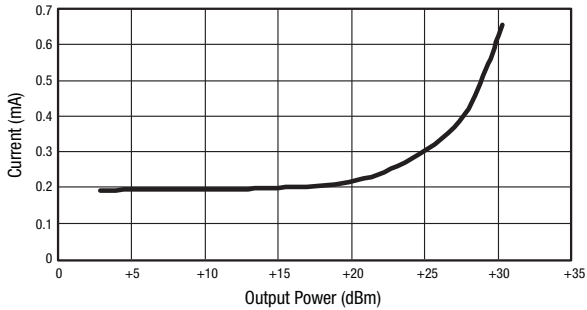


Figure 5. Current vs Output Power (CW)

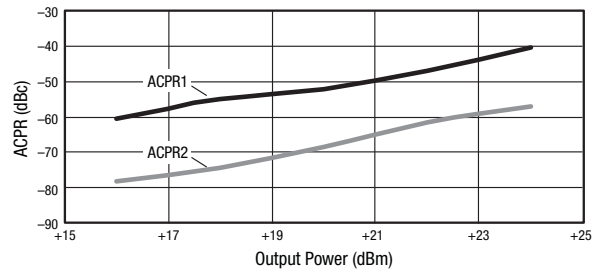


Figure 6. ACPR vs Output Power (CDMA2000)

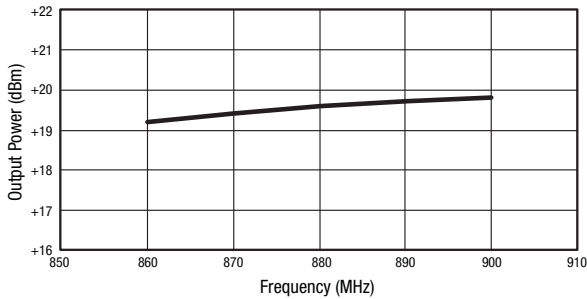


Figure 7. ACLR Limited Output Power vs Frequency (Band V, WCDMA Test Model 1, 64 DPCH, ACLR = -45 dBc)

Evaluation Board Description

The SKY65170-21 Evaluation Board is used to test the performance of the SKY65170-21 High Power PA. A schematic diagram of the SKY65170-21 Evaluation Board is shown in Figure 8. An assembly drawing for the Evaluation Board is shown in Figure 9 and the layer detail is provided in Figure 10. The layer detail physical characteristics are noted in Figure 11.

Package Dimensions

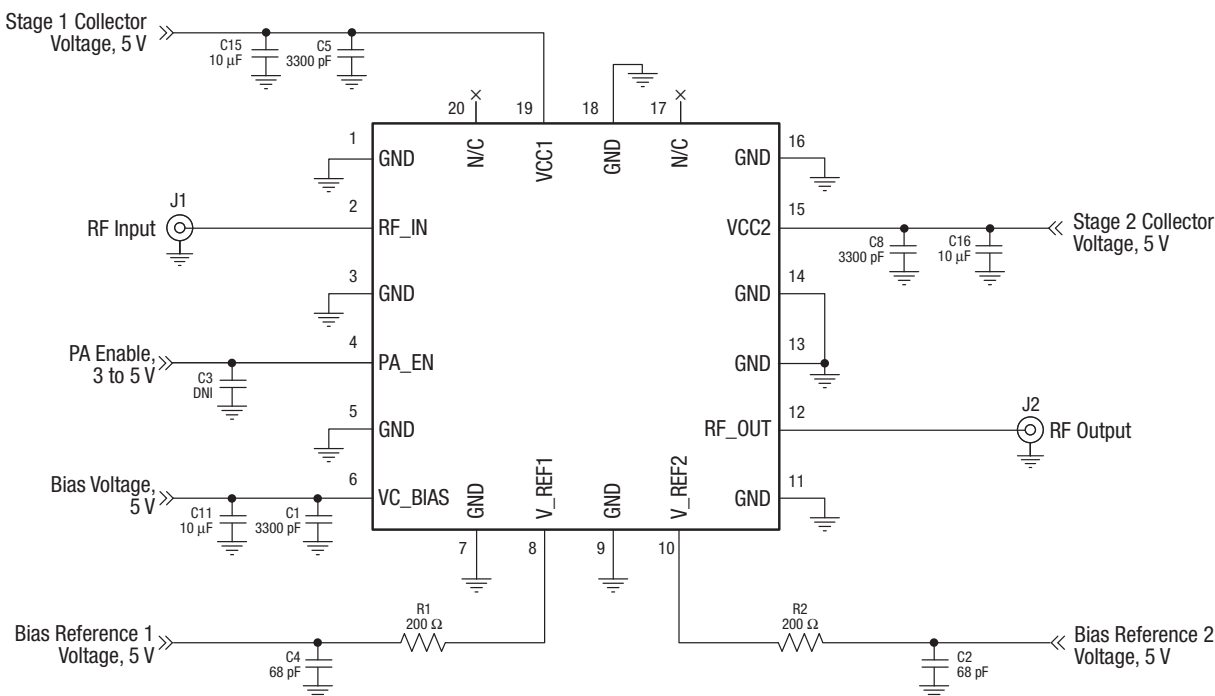
The PCB layout footprint for the SKY65170-21 is provided in Figure 12. Package dimensions for the 20-pin MCM are shown in Figure 13, and tape and reel dimensions are provided in Figure 14.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

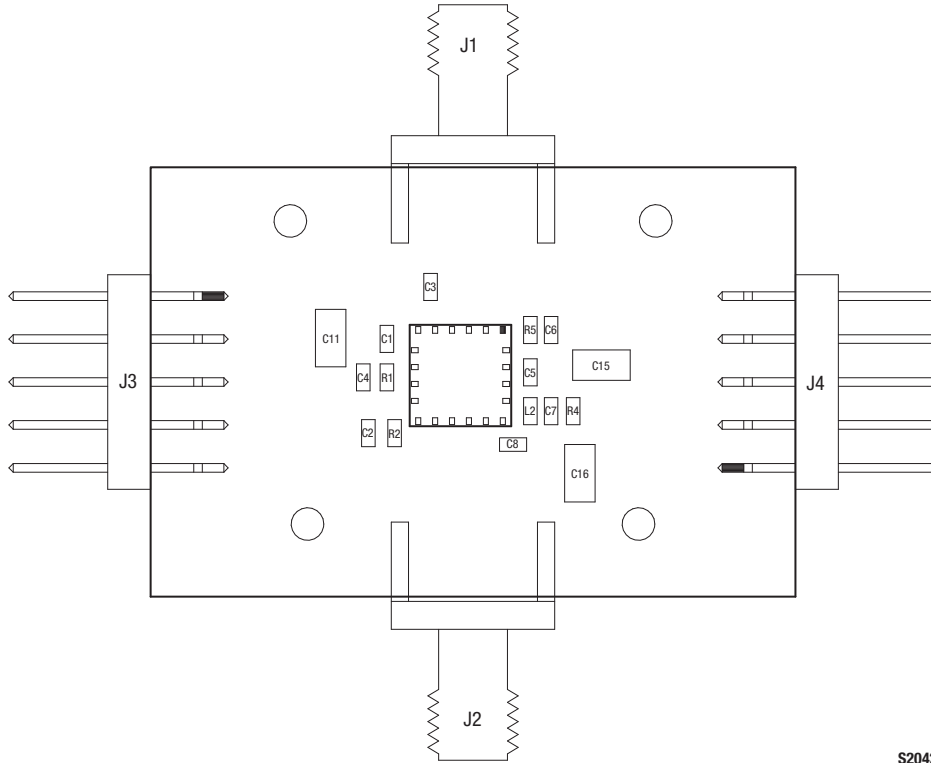
The SKY65170-21 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to Skyworks Application Note, *PCB Design and SMT Assembly/Rework Guidelines for MCM-L Packages*, document number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.



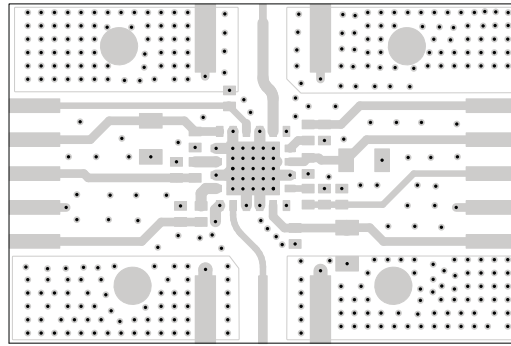
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Figure 8. SKY65170-21 Evaluation Board Schematic

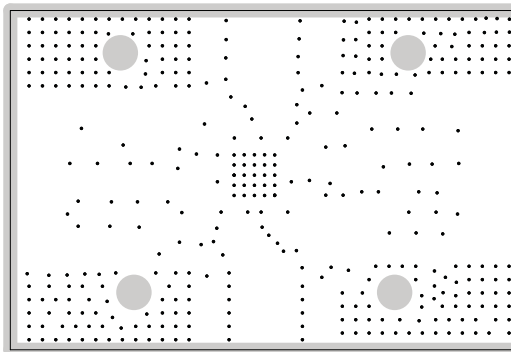


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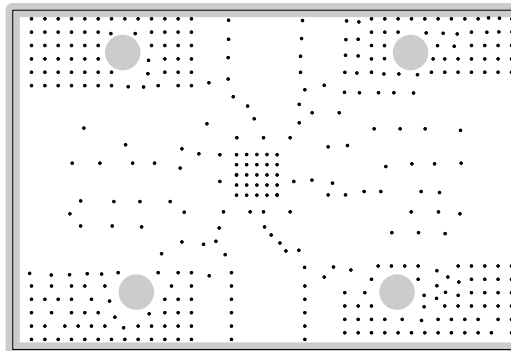
Figure 9. SKY65170-21 Evaluation Board Assembly Drawing



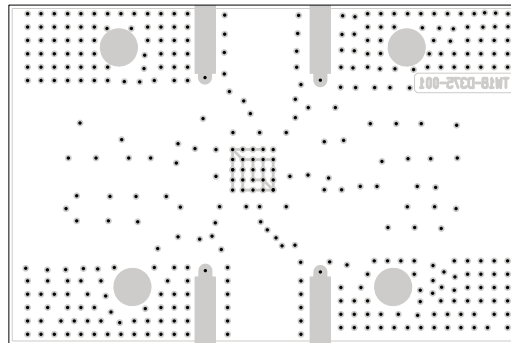
Layer 1: Top – Metal



Layer 2: Ground



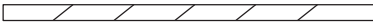
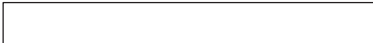





Layer 3: Ground Plane



Layer 4: Solid Ground Plane

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Figure 10. SKY65170-21 Evaluation Board Layer Detail

Cross Section	Name	Thickness (mm)	Material	ϵ_r
	Pri	0.036	Cu, 1 oz.	-
	Die1	0.250	Rogers 4350	3.38
	L2	0.036	Cu, 1 oz.	-
	Die2	0.175	FR4-4	4.35
	L3	0.036	Cu, 1 oz.	-
	Die3	0.250	FR4-12	4.35
	Sec	0.036	Cu, 1 oz.	-

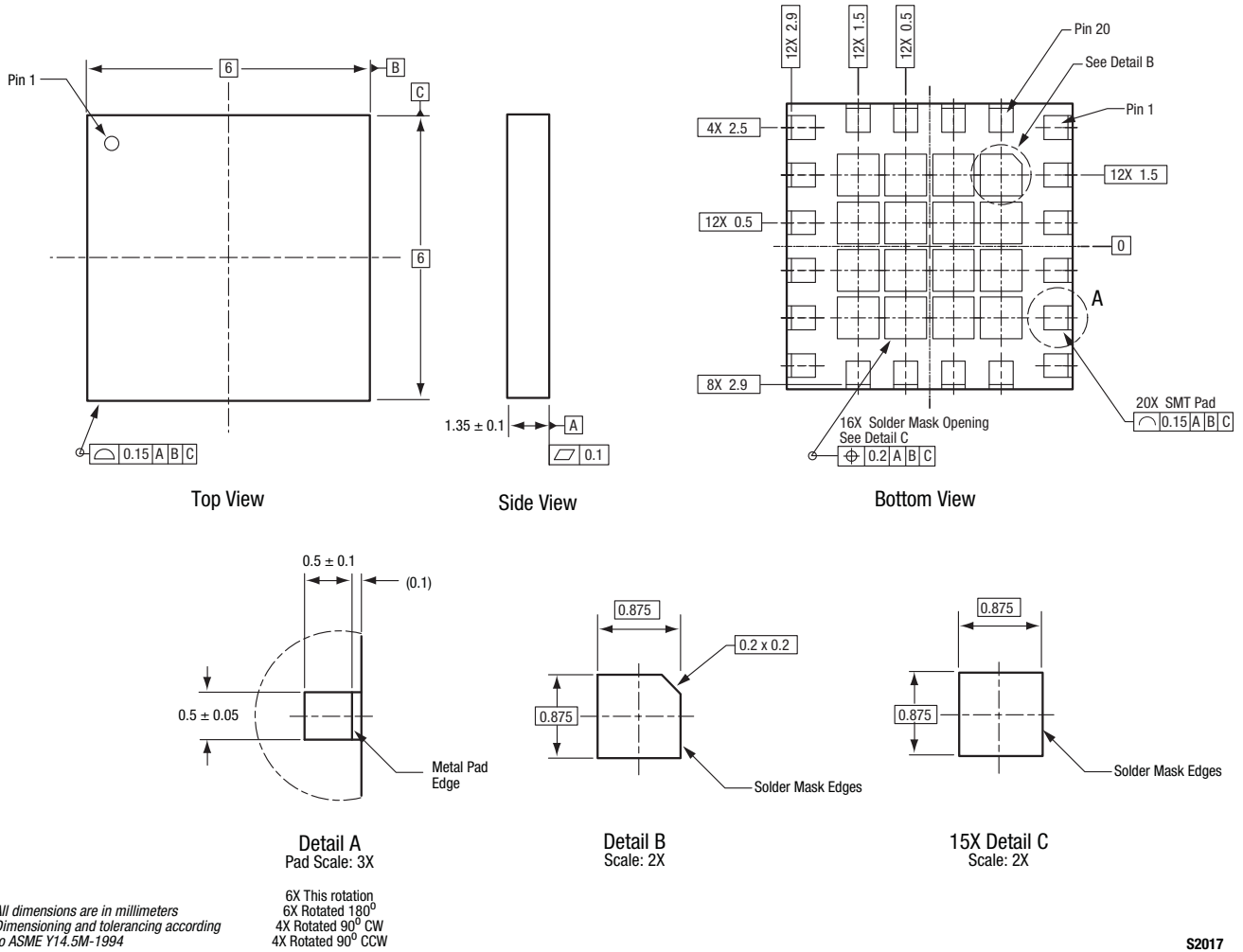
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Figure 11. Layer Detail Physical Characteristics

*** TBD ***

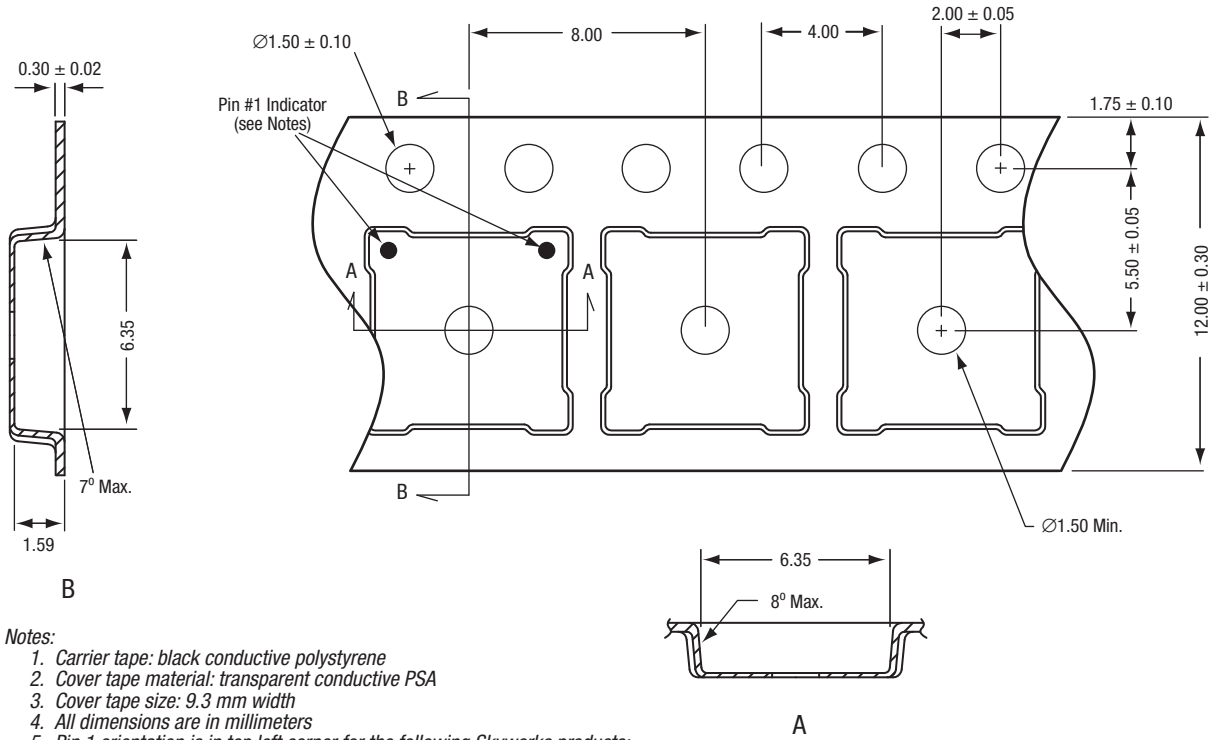
Figure 12. SKY65170-21 PCB Layout Footprint

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Figure 13. SKY65170-21 20-Pin MCM Package Dimensions



Notes:

1. Carrier tape: black conductive polystyrene
2. Cover tape material: transparent conductive PSA
3. Cover tape size: 9.3 mm width
4. All dimensions are in millimeters
5. Pin 1 orientation is in top left corner for the following Skyworks products:

SKY73022-21, -31
SKY73023-21, -31

For all other 6 x 6 mm MCM/RFLGA products, pin 1 orientation is in top right corner.

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Figure 14. SKY65170-21 20-Pin MCM Tape and Reel Dimensions

Ordering Information

Model Name	Manufacturing Part Number	Evaluation Board Part Number
SKY65170-21 860-960 MHz, 0.5 W High Power Power Amplifier	SKY65170-21	TW18-D370

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